



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Farnworth et al.

Serial No.: 09/923,687

Filed: August 6, 2001

For: HERMETIC CHIP SIZE AND  
METHOD OF MANUFACTURE

Confirmation No.: 3349

Examiner: F. Toledo

Group Art Unit: 2823

Attorney Docket No.: 2741.5US  
(95-0804.4)

CERTIFICATE OF MAILING

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AMENDMENT

Commissioner for Patents  
Washington, D.C. 20231

Sir:

This amendment is in response to the Office Action of December 4, 2002, whose initial period of response is set to expire on March 4, 2003.